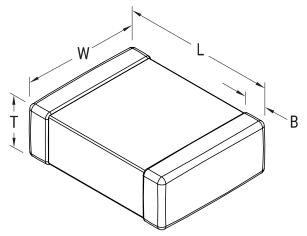




CBR-SMD RF COG, Ceramic, 0.6 pF, +/-0.25 pF, 10 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0201



Click here for the 3D model.

General Information	
Series	CBR-SMD RF COG
Style	SMD Chip
Description	SMD, Fixed, RF, Ultra High Q, Low ESR, Class I
Features	Ultra High Q, Low ESR, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	0.3 mg
Notes	Solder Reflow Only.
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	0201
L	0.6mm +/-0.03mm
W	0.3mm +/-0.03mm
т	0.3mm +/-0.03mm
В	0.15mm +/-0.05mm

В	0.15mm +/-0.05mm	Tempera
		Temp. Co
Packaging Specifications		Dissipati
Packaging	T&R, 180mm, Plastic Tape	Aging Ra
Packaging Quantity	15000	Insulatio

Specifications	
Capacitance	0.6 pF
Tolerance	+/-0.25 pF
Voltage DC	10 VDC
Dielectric Withstanding Voltage	25 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Dissipation Factor	0.243%
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	10 GOhms
Quality Factor	412

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